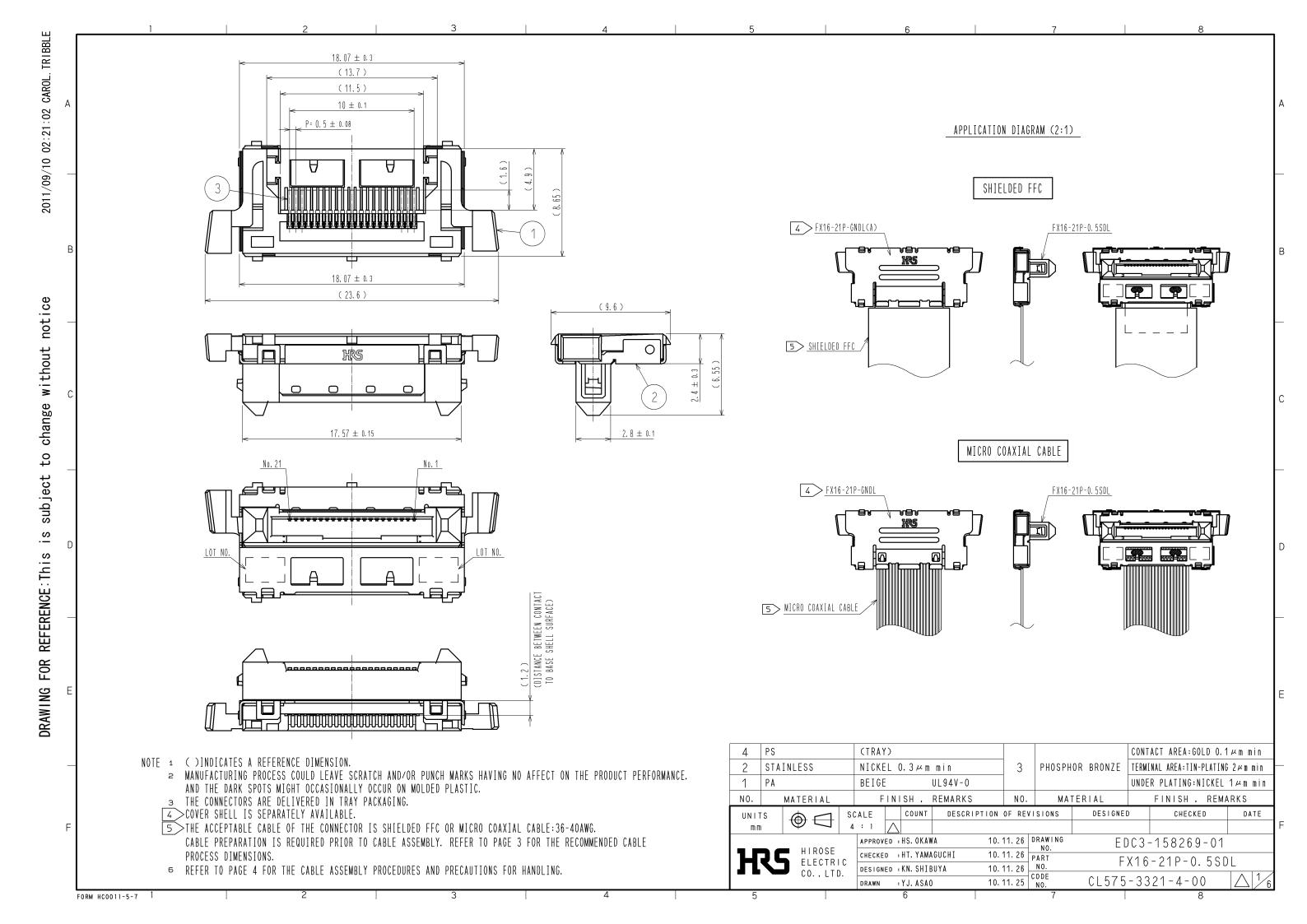
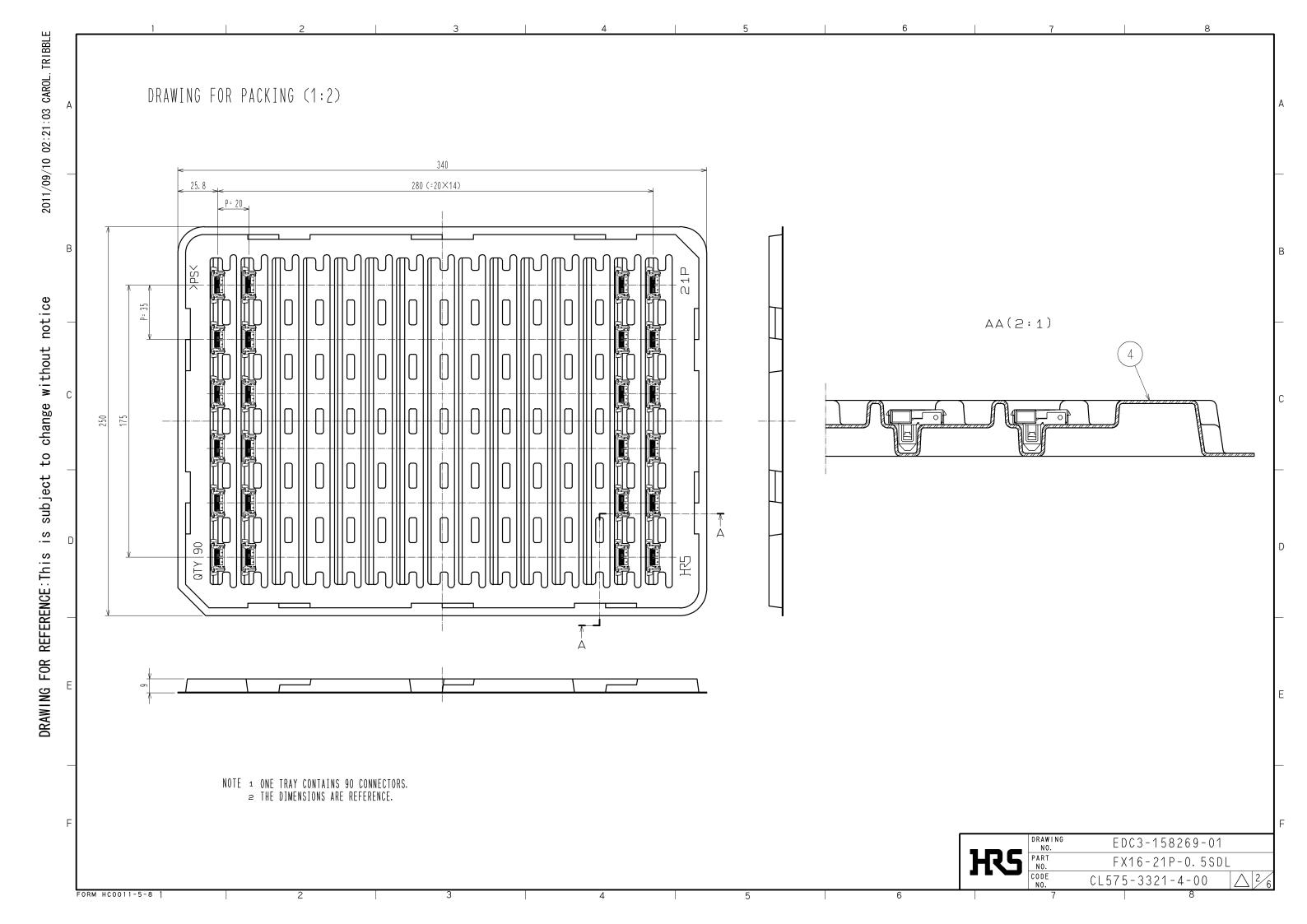
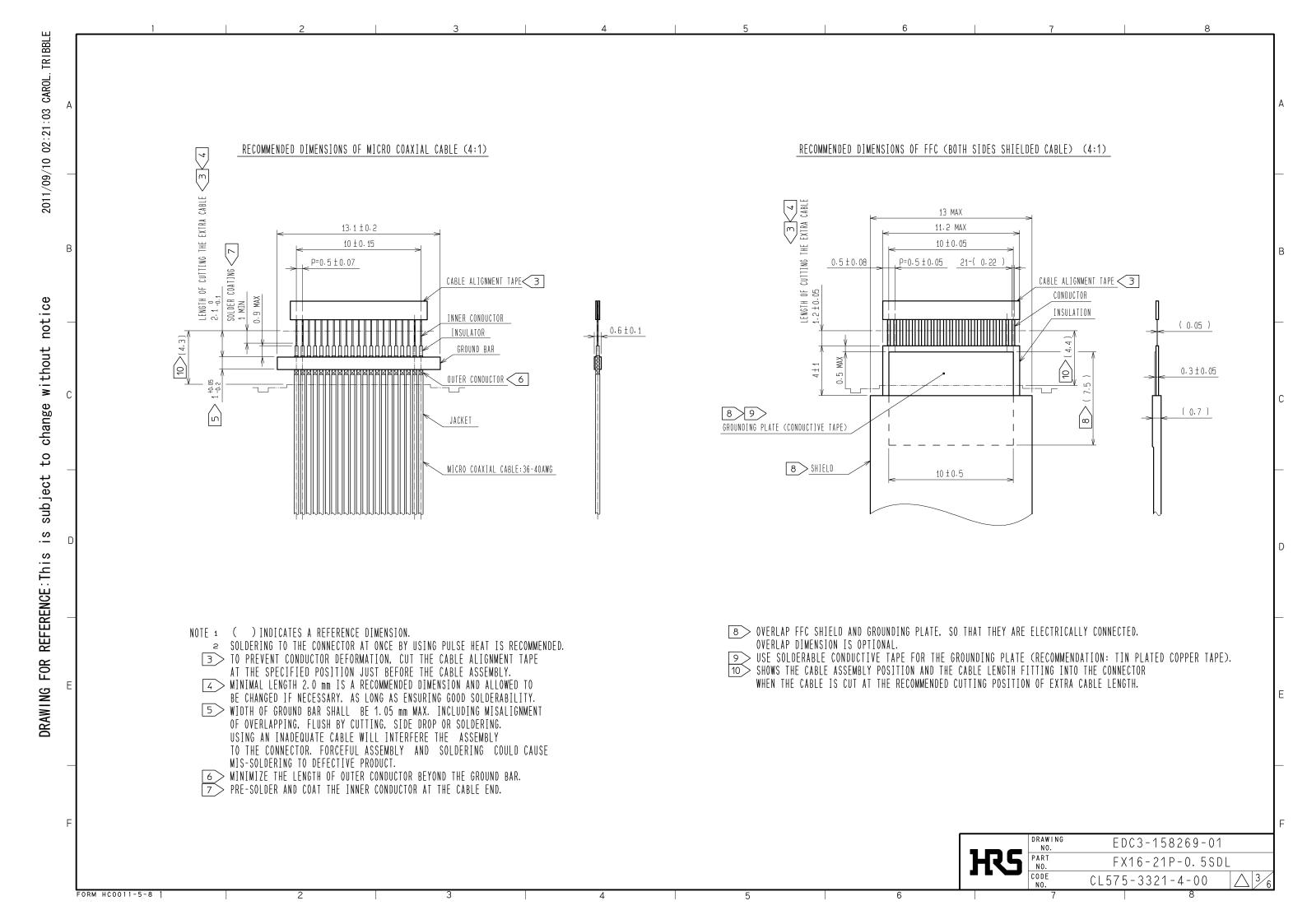
RATING VC CL AP ITEM CONSTRUCT GENERAL EXAMIN MARKING ELECTRIC C CONTACT RESIST INSULATION RES VOLTAGE PROOF	TION INATION VISUALLY	· ·	C (1) (2) TI O R S R AL CABLE /	TORAGE EMPERATU PERATING ANGE TORAGE HI ANGE FFC (6)	HUMIDITY	-10 °C TO 60 °C RH 85 % MAX RH 70 % MAX					
RATING VC CL AP ITEM CONSTRUC GENERAL EXAMIN MARKING ELECTRIC C CONTACT RESIST INSULATION RES VOLTAGE PROOF MECHANICA	OLTAGE URRENT PPLICABLE CABLE VI STION INATION VISUALLY CONFIRM	60 V AC (6) 0.5 A (6) AWG 36,40 THIN COAXIA SPEC TEST METHOD	R S R	PERATING ANGE TORAGE HI ANGE	HUMIDITY	RH 85 % MAX					
ITEM CONSTRUCT GENERAL EXAMINA MARKING ELECTRIC C CONTACT RESIST INSULATION RES VOLTAGE PROOF	URRENT PPLICABLE CABLE VI STION INATION VISUALLY CONFIRM	0.5 A ⁽⁵⁾ AWG 36,40 THIN COAXIA SPEC TEST METHOD	S R	TORAGE HU ANGE	JMIDITY						
ITEM CONSTRUCT GENERAL EXAMINA MARKING ELECTRIC C CONTACT RESIST INSULATION RES VOLTAGE PROOF	PPLICABLE CABLE M TION INATION VISUALLY CONFIRM	AWG 36,40 THIN COAXIA SPEC TEST METHOD	L CABLE /								
ITEM CONSTRUCT GENERAL EXAMING MARKING ELECTRIC C CONTACT RESIST INSULATION RES VOLTAGE PROOF	METION INATION VISUALLY CONFIRM	SPEC TEST METHOD		FFC ®		in the second se					
CONSTRUCT GENERAL EXAMIN MARKING ELECTRIC C CONTACT RESIST INSULATION RES VOLTAGE PROOF	INATION VISUALLY	TEST METHOD		AWG 36,40 THIN COAXIAL CABLE / FFC ® SPECIFICATIONS							
CONSTRUCT GENERAL EXAMIN MARKING ELECTRIC C CONTACT RESIST INSULATION RES VOLTAGE PROOF	INATION VISUALLY				REOLU	IREMENTS	QT	A-			
GENERAL EXAMINATION MARKING ELECTRIC CONTACT RESIST INSULATION RES VOLTAGE PROOF MECHANICA	INATION VISUALLY CONFIRM	AND BY MEASURING INSTRU			NEQU	INCIVILIVIO	العا	<u> </u>			
ELECTRIC C CONTACT RESIST INSULATION RES VOLTAGE PROOF MECHANICA			JMENT.	ACCORE	ING TO DRAV	VING.	×	×			
CONTACT RESIST INSULATION RES VOLTAGE PROOF MECHANICA	CHARACTERISTI	ED VISUALLY.					×	×			
INSULATION RES VOLTAGE PROOF MECHANICA											
VOLTAGE PROOF		20 mV MAX, 1 mA(DC OR 1000Hz)			80mΩ MAX. ⁽⁷⁾						
MECHANICA	SISTANCE 100 V DC.	100 V DC.			500 MΩ MIN.						
		FOR 1 min.	NO FLAS	SHOVER OR BI	REAKDOWN.	×					
INSERTION AND	AL CHARACTERI										
WITHDRAWAL FC	ORCES	ED BY APPLICABLE CONNECT		WITHDR	AWAL FORCE	10.5 N MAX. : 1.05 N MIN.	×				
MECHANICAL OPI	PERATION 50 TIMES) TIMES INSERTIONS AND EXTRACTIONS.			 CONTACT RESISTANCE: NO VARIATION OF 20 mΩ OR MORE FROM INITIAL VALUE. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 		×				
VIBRATION	SINGL AM	EQUENCY 10 TO 55 Hz, GL AMPLITUDE : 0.75 mm, 2 h FOR 3 DIRECTION.		① NO E ② NO D	① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.		×				
SHOCK		90 m/s ² , DURATION OF PULSE 11 ms					×				
LOCK STRENGTH		ATE TO APPLICABLE CONNECTOR AND APPLY JLL FORCE HORIZONTALLY.			30 N MIN.		×				
ENVIRONME	ENTAL CHARAC	TERISTICS		l			-				
DAMP HEAT		AT 40±2 °C, 90 ~ 95 %,	96 h.	_	ACT RESISTA		×				
(STEADY STATE)	·	ΔT 85+2°C 96 h			ARIATION OF // INITIAL VALU	20 mΩ OR MORE					
DRY HEAT RAPID CHANGE C		TIME 30→ 5 MAX→ 30→5 MAX min. UNDER 5 CYCLES.			 ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS. ① CONTACT RESISTANCE:NO VARIATION OF 20 mΩ OR MORE FROM INITIAL VALUE. ② NO DEFECT SUCH AS CORROSION WHICH IMPAIRS THE FUNCTION OF CONNECTOR. 			-			
TEMPERATURE	TIME										
CORROSION SAL	LT MIST EXPOSED										
SULFUR DIOXIDE											
SOLDERING HEAT PRESS (COAX (FFC) H		PRESSURIZATION:15±2N (COAXIAL CABLE) HEATING Y:275±5°C, X:2±0.5 sec (FFC) HEATING Y:265±5°C, X:2.5±0.5 sec Y°C 220°C 220°C 220°C 220°C 220°C 220°C		LOOSEN	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINAL.		×				
SOLDERABILITY		2) SOLDERING IRONS : 360°C MAX. FOR 3 sec. SOLDERED AT SOLDER TEMPERATURE			JNIFORM COA	TING OF SOLDER SHALL	×	\vdash			
		C FOR IMMERSION DURATION, 3 sec.		COVER	COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.						
COUNT	DESCRIPTI	ON OF REVISIONS	DES	SIGNED		CHECKED	DA	TE			
<u>/</u> 2 2	DIS	S-F-004353	KN.	SHIBUYA		HT. YAMAGUCHI	09. 1	2. 1			
(2) OI	OPERATING TEMPERATURE SH	RISE CAUSED BY CURRENT-CARRYING. RE SHOULD BE -55 TO 40°C WHEN HUMIDITY EXCEEDS 80% RH. PPLIED TO THE PRE-ASSEMBLED COMPONENT AND THE CABLE			APPROVED	HS. OKAWA	08.0	5. 24			
	DELIVERY AND STORAGE, BEFORE ASS			CHECKED	HT. YAMAGUCHI	08.0	5. 24				
(6) IT IS THE MAXIMUM VALUE OF CONNECTOR. CONFIRM THE SPECIFICATION OF THE CA (6) ONLY FFC THAT PROCESSES THE TERMINAL THAT WE SPECIFIED. (7) DON'T INCLUDE CONDUCTOR RESISTANCE OF CABLE. Unless otherwise specified, refer to JIS-C-5402. Note QT:Qualification Test AT:Assurance Test X:Applicable Test SPECIFICATION SHEET			ION OF THE CABLE.		DESIGNED	TS. SHIBUYA	08.0	5. 13			
				DRAWN TS. SHII		TS. SHIBUYA	08. 05. 1				
			st	DRAWIN	G NO. ELC4-1582		9-00				
			PA	RT NO.		FX16-21P-0. 5SDL					
	HIROSE E	LECTRIC CO., LTD.	CO	DE NO.	<u>CL</u> 57	5-3321-4-00	<u> </u>	1/1			







Cautions for soldering

1. Recommended solder

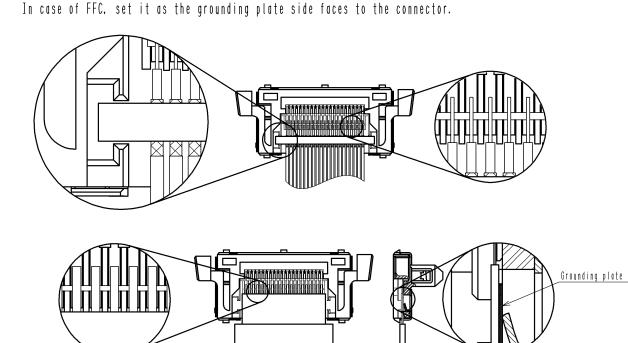
Flux cored solder (Lead-free: Sn-3Ag-0.5Cu)

Micro coaxial cable · · · 0.15 mm dia. Length 10.5 mm · - · 0.1 mm dia, Length 10.5 mm

If you consider using additional flux, please pay enough attention not to have flux wicking to the contact area. Flux wicking to the contact area will cause contact failure.

2. Setting the cable

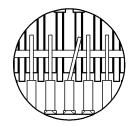
Set the conductors as each conductor is placed at the center of the contact. In case of micro cooxial cable, set it as the metal bar fits in the guide on the connector.

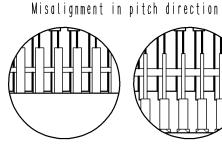


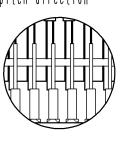
- 3. Place the cable to the connector and check the below points before soldering by pulse heat.
 - Transformation of conductor
 - · Misalignment of conductor to the terminals in pitch direction
 - Excessive floating of conductor

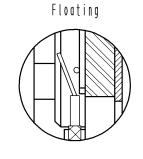
The above could cause soldering failure and/or solder bridge.

Transformation of conductor





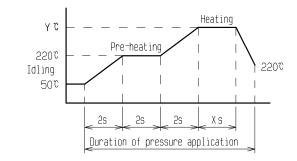




- 4. Follow the recommended temperature profile shown below for the soldering.
 - The optimum condition could vary depending on various factors including type of cable and its length, solder type. Therefore refer to the recommended temperature profile and optimize the condition if necessary.

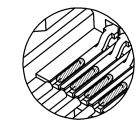
Solder tip pressurization	13 ~ 17 N
hi coonii Tarion	

heating	Micro coaxial cable	FFC
Temperature (Y)	275± 5 ℃	265± 5 ℃
Duration (X)	2± 0.5 sec	2.5± 0.5 sec



5. After soldering, check that no defect is found at soldered area. Examples of correct soldered and defective soldered state are shown below.

Correct soldering

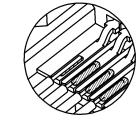


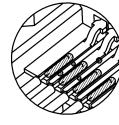
Conductors are placed at the center of the contact, and whole area is equally wetted.

Defective soldered state



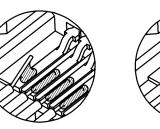
Solder bridge

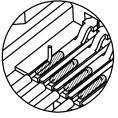


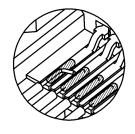


Solder shortage

Solder ball dispersion







Floating

Conductor sticking out The conductor approaches

to the adjacent contact

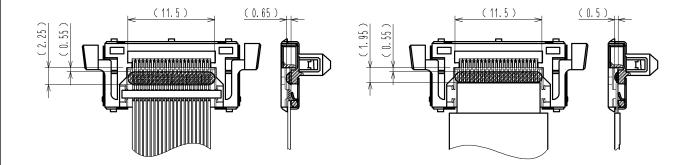
*Note: The figures shown in this page are solely for the instruction purpose. Therefore the appearance could differ from the actual connectors. Refer to the drawing for the actual design (sheet 1).

	DRAWING NO.	EDC3-158269-01		
H 75	PART NO.	FX16-21P-0.5SDL		
	CODE NO.	CL575-3321-4-00	\triangle	4/6
		0		

FORM HC0011-5-8

Cautions for potting process

- 1. Protect the soldered area by UV cured resin or any equivalent (referred to as 'potting' hereafter). In order to prevent insulating failure caused by metal adhering, cable breakage during cabling and other troubles.
- 2. Apply 3033 manufactured by THREEBOND CO., LTD. or any equivalent product for potting. Follow the instruction of potting manufacture's for the condition of UV exposure.
- 3. Refer to the following conditions for the potting area.



4. Use extreme care for the handling after soldering to the end of potting process not to apply stress to the cable, otherwise, cable could be broken.

Exercise extreme caution during the process so that no resin flows or adheres to the contact area.

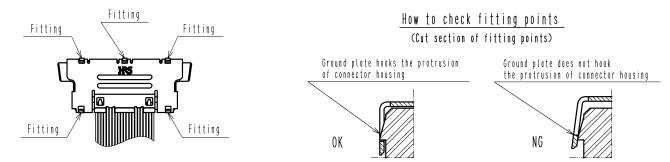
Cautions for cover shell assembly

1. Attach a cover shell separately provided after the cable assembly process.

For micro coaxial cabla : FX16-21P-GNDL
For FFC : FX16-21P-GNDL(A)

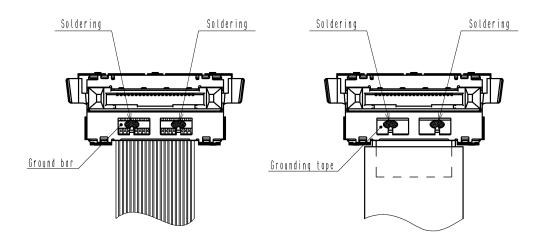
2. Place the cover shell onto the connector horizontally and pinch two components from top and bottom with fingers.

3. Check the five fitting points after assembly and make sure that they are all correctly fitted together.



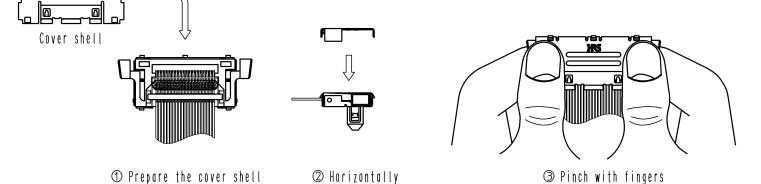
Soldering to ground plate

1. Solder down the metal bar of the cable and ground plate after the assembly of ground plate in order to enhance the grounding performance and robustness against cable stroke to up and down direction.



2. Excess solder and/or excess heating could cause cable and connector deformation and/or melt.

Cable assembly process is completed.



from the top

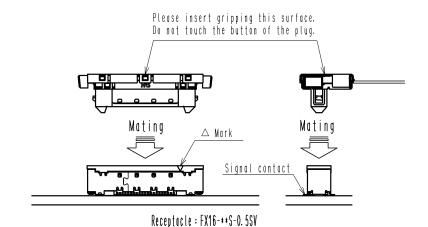
*Note: The figures shown in this page are solely for the instruction purpose. Therefore, the appearance could differ from the actual connectors. Refer to the drawing for the actual design (sheet 1).

		DRAWING NO.	EDC3-158269-01	
	HZ5	PART NO.	FX16-21P-0.5SDL	
		CODE NO.	CL575-3321-4-00	5/6
		7	Ω	

Handling instructions

1. Insertion to on-board connector

The connector mating is keyed. Align the marks as shown in the figure for mating. Insert the connector complétely until they are locked at both ends.



The connectors have a reverse-insertion prevention structure, however, the connectors may be damaged when inserted reversely with the force of 25 N or more. Avoid a forceful insertion, and make sure to confirm that the connectors are aligned with the marks before the mating operation.

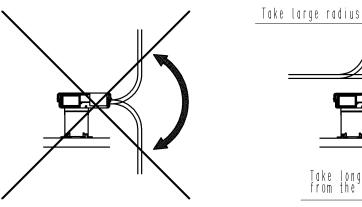
2. After mating

FORM HC0011-5-8

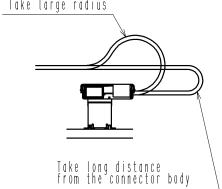
Carefully wire cables, so that excessive force will not be applied to the mated connectors. Pulling the cable with the force of 20 N or more may damage the connectors. It may also cause cable breakage. Take a caution to avoid pulling the cables.

Repetitive cable strokes could also cause cable breakage as well. Do not use the connector under the environment of repetitive cable strokes.

Take enough bend radius and/or distance from the connector for the cable not to apply stress to the connector base when the application requires cable bend back.



Repetitive cable strokes



Application of cable bend back

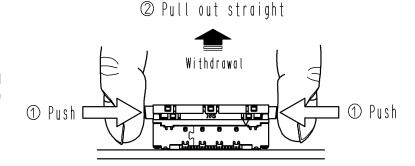
*Note: The connectors shown in this page are drawn for the instruction purpose, therefore, the appearance differs from the actual connectors.

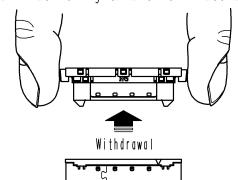
3. Withdrawal from on-board connector

The connectors are locked while they are mated. In order to unmate the connectors, pull out straight, with the button pushed to release the lock. At this time, do not pull the cable. Also, avoid the withdrawal in angle, which may damage the connectors.

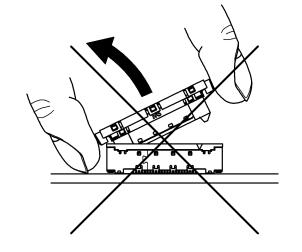
<Correct withdrawal>

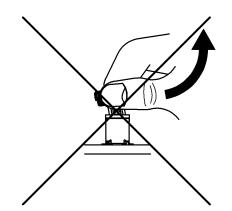
3 Pull out straight, with the button pushed.

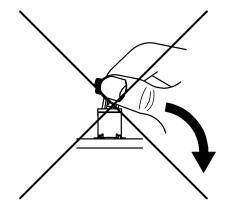












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	PART NO.	FX16-21P-0.5SDL		
	CODE NO.	CL575-3321-4-00 Z	$\overline{\ }$	6

Please confirm the connector configuration on the connector drawing (SHEET 1).